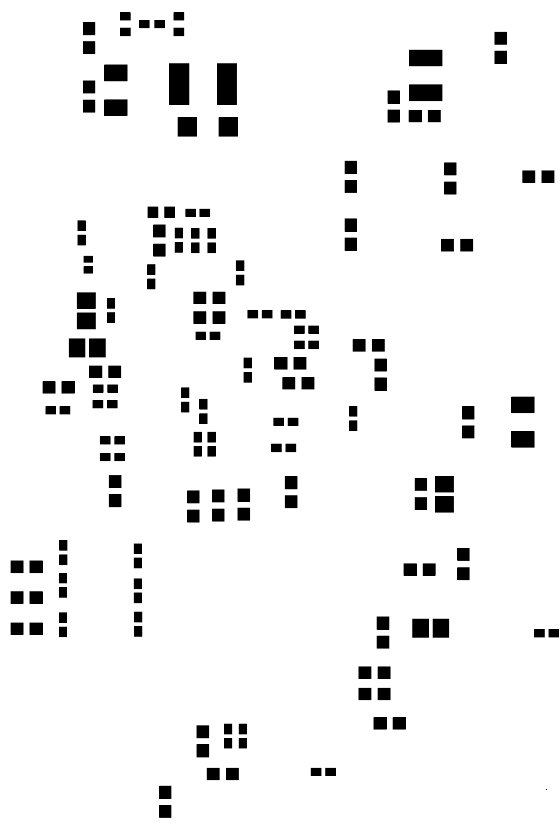


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Paste	TIDA-00226 (ISE5001)		
PLOT NAME = ISE5001.GTP	GENERATED:	6/25/2014 6:48:53 PM	TEXAS INSTRUMENTS



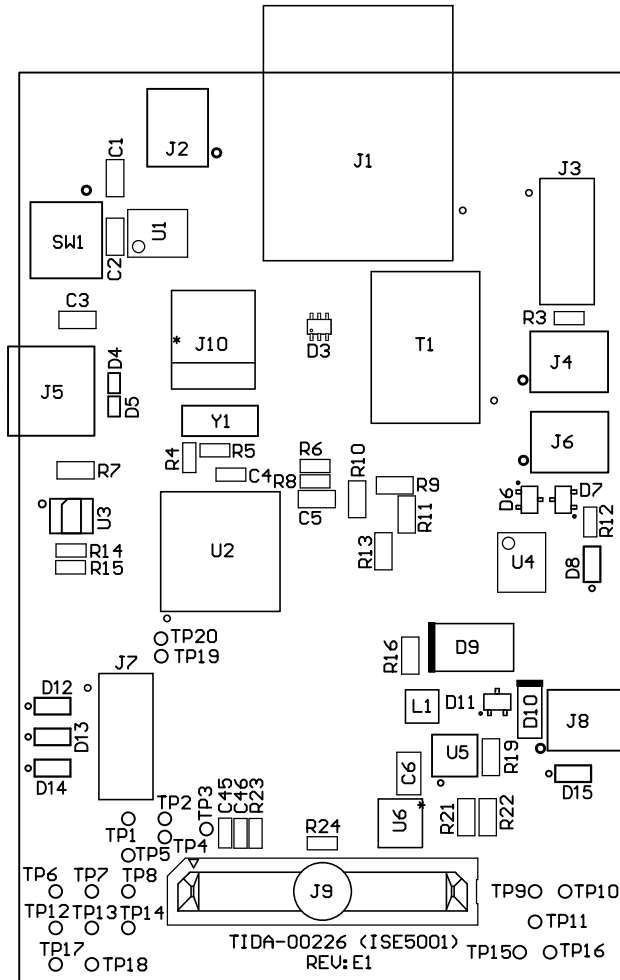
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste	TIDA-00226 (ISE5001)		
PLOT NAME = ISE5001.GBP	GENERATED:	6/25/2014 6:48:54 PM	TEXAS INSTRUMENTS

Z24 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

Z23 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

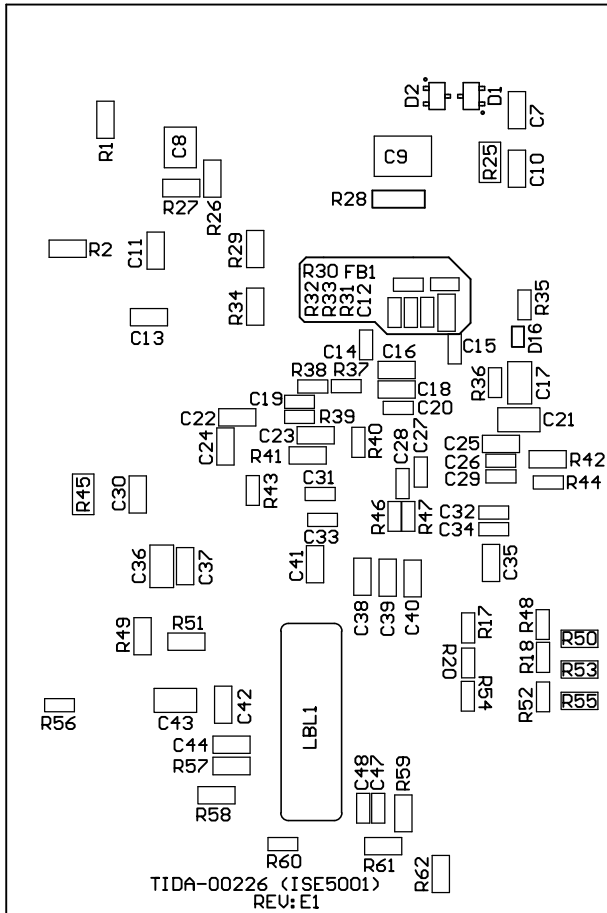
Z21 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Z22 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



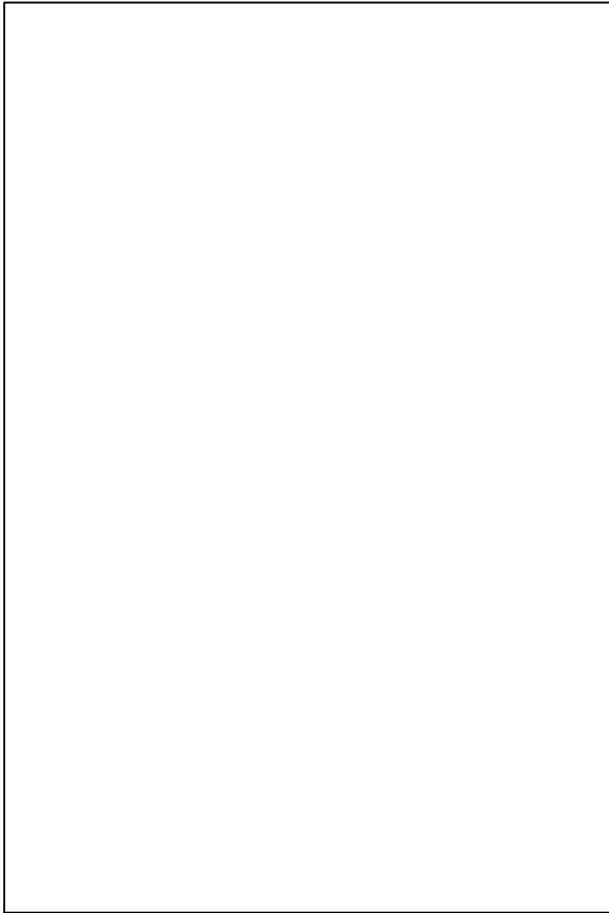
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #:	REV:E1	SUN REV: Not In VersionControl
LAYER NAME = ASSEMBLY TOP	TIDA-00226 (ISE5001)		
PLOT NAME= ISE5001.GM5	GENERATED	: 6/25/2014 6:44:49 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #:	REV:E1	SUN REV: Not In VersionControl
LAYER NAME = ASSEMBLY BOTTOM	TIDA-00226 (ISE5001)		
PLOT NAME=ISE5001.GM6	GENERATED:	6/25/2014 6:44:49 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline	TIDA-00226 (ISE5001)		
PLOT NAME = ISE5001.GM1	GENERATED:	6/25/2014 6:48:54 PM	TEXAS INSTRUMENTS

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